JUN 2 2 2004 35



Applicant

: LIN et al.

Confirmation No: 2668

Appl. No.

: 10/045,004

Filed

: January 15, 2002

Title

: LEAD-FREE SOLDER

TC/A.U.

: 1742

Examiner

: S. lp

Docket No.:

: LINK3019/REF

Customer No:

: 23364

AMENDMENT AFTER FINAL

MS AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

This is in response to the Official Action of March 23, 2004, in connection with the above-identified application. This response is timely filed.

Please amend the application as follows:

Amendments to the claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 3 of this paper.